

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10519152			
<b>Filing Date:</b>	10-Aug-2005			
<b>Title of Invention:</b>	Porous substrate and its manufacturing method, and gan semiconductor multilayer substrate and its manufacturing method			
<b>First Named Inventor/Applicant Name:</b>	Masatomo Shibata			
<b>Filer:</b>	James B Conte/Colleen Dunphy			
<b>Attorney Docket Number:</b>	PHCF-03037US			
Filed as Large Entity				
<b>U.S. National Stage under 35 USC 371 Filing Fees</b>				
<b>Description</b>	<b>Fee Code</b>	<b>Quantity</b>	<b>Amount</b>	<b>Sub-Total in USD(\$)</b>
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
Petition-revive unintent. abandoned appl	1453	1	1540	1540
<b>Patent-Appeals-and-Interference:</b>				
Post-Allowance-and-Post-Issuance:				
<b>Extension-of-Time:</b>				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension - 3 months with \$0 paid	1253	1	1050	1050
<b>Miscellaneous:</b>				
<b>Total in USD (\$)</b>				<b>2590</b>